

# DELO DUALBOND® GE7065

**modified epoxy resin | 1C | light-fixable / heat-curing**

free of solvents | heat curing mandatory, light-fixable, thixotropic, filled, low CTE

**Special features of product**

- compliant with RoHS Directive 2015/863/EU

**Function**

- glob top

**Typical area of use**

- -65 - 220 °C

**Curing**

Suitable lamp types	LED 400 nm	
Typical light fixation time		
<i>intensity 1,000 mW/cm<sup>2</sup> LED 400 nm</i>	5	s
Typical curing time		
<i>at +130 °C in air convection oven</i>	60	min
<i>at +150 °C in air convection oven</i>	20	min

**Processing**

Conditioning time (typical)		
<i>when stored in cold conditions in containers up to 10 ml</i>	0.5	h
Processing time		
<i>in standard climate +23 °C / 50 % r. h.</i>	48	h
Storage life in unopened original container		
<i>at -45 °C to -35 °C</i>	6	month(s)

### Technical properties

Color in cured condition in 1 mm layer thickness	black
Transparency in cured condition in 1 mm layer thickness	opaque
Filler particle type	minerals
Filler particle size	d95 = 7 µm

### Parameters

Density <i>by the criteria of DIN 66137-2   liquid</i>	1.71	g/cm <sup>3</sup>
Viscosity <i>liquid   Rheometer   Shear rate: 10 1/s   Gap: 500 µm</i>	55000	mPa·s
Thixotropy index <i>liquid   Rheometer   Gap: 500 µm</i>	4.5	
Compression shear strength <i>DELO Standard 5   AI   AI   Pretreatment: sand-blasted   150 °C   20 min</i>	35	MPa
Compression shear strength <i>DELO Standard 5   AI   AI   Pretreatment: sand-blasted   150 °C   20 min   Measuring temperature: 150 °C</i>	14	MPa
Compression shear strength <i>DELO Standard 5   AI   AI   Pretreatment: sand-blasted   150 °C   20 min   Measuring temperature: 200 °C</i>	11	MPa
Compression shear strength <i>DELO Standard 5   AI   AI   Pretreatment: sand-blasted   150 °C   20 min   Measuring temperature: 220 °C</i>	10	MPa
Compression shear strength <i>DELO Standard 5   FR4   FR4   Pretreatment: Annealing   150 °C   20 min</i>	50	MPa
Compression shear strength <i>DELO Standard 5   PPS   PPS   150 °C   20 min</i>	22	MPa
Tensile strength <i>by the criteria of DIN EN ISO 527   400 nm   1000 mW/cm<sup>2</sup>   5 s   Plus   150 °C   20 min</i>	84	MPa
Elongation at tear <i>by the criteria of DIN EN ISO 527   400 nm   1000 mW/cm<sup>2</sup>   5 s   Plus   150 °C   20 min</i>	1	%
Young's modulus <i>DMTA   400 nm   1000 mW/cm<sup>2</sup>   5 s   Plus   150 °C   20 min</i>	13000	MPa

Shore hardness D <i>by the criteria of DIN EN ISO 868   150 °C   20 min</i>	>90	
Glass transition temperature <i>DMTA   400 nm   1000 mW/cm²   5 s   Plus   150 °C   20 min</i>	218	°C
Coefficient of linear expansion <i>DELO Standard 26   TMA   Evaluation T: -40 °C - 140 °C   400 nm   1000 mW/cm²   5 s   Plus   150 °C   20 min</i>	19	ppm/K
Coefficient of linear expansion <i>DELO Standard 26   TMA   Evaluation T: 210 °C - 240 °C   400 nm   1000 mW/cm²   5 s   Plus   150 °C   20 min</i>	76	ppm/K
Shrinkage <i>DELO Standard 13   400 nm   1000 mW/cm²   5 s   Plus   150 °C   20 min</i>	1.6	vol. %
Water absorption <i>by the criteria of DIN EN ISO 62   Layer thickness: 4 mm   150 °C   20 min   Type of storage: Media   Medium: Distilled water   Duration: 24 h</i>	0.09	wt. %
Extractable ions <i>Ion: Chloride</i>	<5	ppm
Extractable ions <i>Ion: Fluoride</i>	<5	ppm
Extractable ions <i>Ion: Potassium</i>	5.2	ppm
Extractable ions <i>Ion: Sodium</i>	<5	ppm
Volume resistivity <i>by the criteria of DIN EN 62631-3-1   150 °C   20 min</i>	>1E15	Ohm·cm
Surface resistance <i>by the criteria of DIN EN 62631-3-2   150 °C   20 min</i>	>1E12	Ohm
Dielectric strength <i>by the criteria of DIN EN 60243-1   150 °C   20 min</i>	38	kV/mm
Relative permittivity <i>by the criteria of DIN 53483-2   150 °C   20 min   1 kHz</i>	3.4	
Relative permittivity <i>by the criteria of DIN 53483-2   150 °C   20 min   1 MHz</i>	3.3	
Relative permittivity <i>by the criteria of DIN 53483-2   150 °C   20 min   100 kHz</i>	3.3	

**Converting table**

°F	= (°C x 1.8) + 32	1 MPa	= 145.04 psi
1 inch	= 25.4 mm	1 GPa	= 145.04 ksi
1 mil	= 25.4 µm	1 cP	= 1 mPa·s
1 oz	= 28.3495 g	1 N	= 0.225 lb

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**General curing and processing information**

The curing time stated in the technical data was determined in the laboratory. It can vary depending on the adhesive quantity and component geometry and is therefore a reference value. The heating time of the components must be added to the actual curing time. It depends on component size and type of heat input. The specified curing temperature must be reached directly at the adhesive. Increasing or decreasing the curing temperature and / or irradiation intensity and / or irradiation time shortens or prolongs the curing time and can lead to changed physical properties. Depending on the adhesive quantity used, exothermic reaction heat is generated which can lead to overheating. In this case, a lower curing temperature is to be selected. All curing or light fixation parameters depend on material thickness and absorption, adhesive layer thickness, lamp type and distance between lamp and adhesive layer. Optional pre-fixation is performed with light. Heat curing is mandatory. Values measured after 24 h at approx. 23 °C / 50 % r.h., unless otherwise specified.

**General**

The data and information provided are based on tests performed under laboratory conditions. Reliable information about the behavior of the product under practical conditions and its suitability for a specific purpose cannot be concluded from this. It is the customer's responsibility to test the suitability of a product for the intended purpose by considering all specific requirements and by applying standards the customer deems suitable (e. g. DIN 2304-1). Type, physical and chemical properties of the materials to be processed with the product, as well as all actual influences occurring during transport, storage, processing and use, may cause deviations in the behavior of the product compared to its behavior under laboratory conditions. All data provided are typical average values or uniquely determined parameters measured under laboratory conditions. The data and information provided are therefore no guarantee for specific product properties or the suitability of the product for a specific purpose.

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All products provided by DELO are subject to DELO's General Terms of Business. Verbal ancillary agreements are deemed not to exist.

**Instructions for use**

You can find further details in the instructions for use.

The instructions for use are available on [www.DELO-adhesives.com](http://www.DELO-adhesives.com).

We will be pleased to send them to you on demand.

**Occupational health and safety**

See material safety data sheet.

### Specification

Nothing contained in this Technical Datasheet shall be interpreted as any express warranty or guarantee. This Technical Datasheet is for reference only and does not constitute a product specification. Please ask our responsible Sales Engineer for the applicable product specification which includes defined ranges. DELO is neither liable for any values and content of this Technical Datasheet nor for oral or written recommendations regarding the use, unless otherwise agreed in writing. This limitation of liability is not applicable for damages resulting from intent, gross negligence or culpable breach of cardinal obligations, nor shall it apply in case of death or personal injury or in case of liability under any applicable compulsory law.

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